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Printed Circuit Board Modular Jacks (Continued)



Modular Jacks

- Performance exceeds Near End Crosstalk (NEXT) requirements of -40dB at 100 MHz per EIA/TIA 568A
- Meets all dimensional. tolerance and metallic plating requirements of FCC Part 68
- Available in single port or multiple port configurations, shielded or unshielded
- Accurately positioned solder tails reduce assembly labor while selectively deposited gold plating results in lower cost
- Eliminate need for customized printed circuit board compensation to achieve high performance

Material and Finish:

Housing - Polyester, Black, UL 94V-0 rated

Contact - Phosphor bronze, gold over nickel plated in contact area, tin-lead over nickel in solder area Shield - Brass, bright tin-lead plated

Specifications

Current - 1.5 amperes maximum at 25°C

Operating Temperature --40°C to 70°C

Insulation Resistance -500 megohms minimum Dielectric Withstanding Voltage -

1000 VAC, RMS Mating/Unmating Forces -5 pounds maximum

750 minimum

Filtered jacks.

0 Traditional Solder Tail Sequence



Application Specifications 114-02048

108-01163-2

For drawings or technical data, contact your AMP sales engineer or call the AMP Product Information Center: 1-800-522-6752. Dimensions are in inches and millimeters unless otherwise specified. Values in brackets are metric equivalents Specifications subject to change. Consult AMP for latest specifications.

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